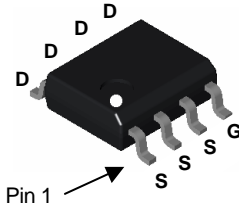
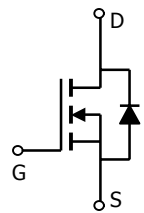
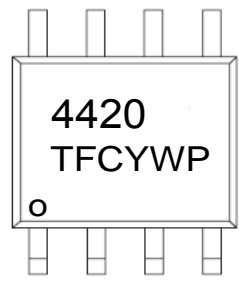


N-Channel Enhancement Mode Power MOSFET

<p><b>Description</b></p> <p>The 4420 uses advanced trench technology to provide excellent <math>R_{DS(ON)}</math> and low gate charge . The complementary MOSFETs may be used to form a level shifted high side switch, and for a host of other applications.</p> <p><b>General Features</b></p> <table border="1" style="width:100%; border-collapse: collapse; margin: 10px 0;"> <thead> <tr> <th colspan="3">PRODUCT SUMMARY</th> </tr> <tr> <th><math>V_{DSS}</math></th> <th><math>I_D</math></th> <th><math>R_{DS(on)}</math> (m<math>\Omega</math>) Max</th> </tr> </thead> <tbody> <tr> <td rowspan="2">30V</td> <td>12 A</td> <td>10.5 @ <math>V_{GS} = 10V</math></td> </tr> <tr> <td>8 A</td> <td>12.0 @ <math>V_{GS} = 4.5V</math></td> </tr> </tbody> </table> <ul style="list-style-type: none"> <li>● High power and current handing capability</li> <li>● Lead free product is acquired</li> <li>● Surface mount package</li> </ul>	PRODUCT SUMMARY			$V_{DSS}$	$I_D$	$R_{DS(on)}$ (m $\Omega$ ) Max	30V	12 A	10.5 @ $V_{GS} = 10V$	8 A	12.0 @ $V_{GS} = 4.5V$	<p><b>SO-8L</b></p>  <p><b>Equivalent Circuit</b></p>  <p><b>MARKING</b></p>  <p>Y :year code    W :week code</p>
PRODUCT SUMMARY												
$V_{DSS}$	$I_D$	$R_{DS(on)}$ (m $\Omega$ ) Max										
30V	12 A	10.5 @ $V_{GS} = 10V$										
	8 A	12.0 @ $V_{GS} = 4.5V$										

Absolute Maximum Ratings $T_A=25^\circ C$ unless otherwise noted			
Parameter	Symbol	Maximum	Units
Drain-Source Voltage	$V_{DS}$	30	V
Gate-Source Voltage	$V_{GS}$	$\pm 12$	V
Continuous Drain Current <sup>A</sup>	$T_A=25^\circ C$	$I_D$	A
Pulsed Drain Current <sup>B</sup>		$I_{DM}$	
Power Dissipation <sup>A</sup>	$T_A=25^\circ C$	$P_D$	W
	$T_A=70^\circ C$		
Junction and Storage Temperature Range	$T_J, T_{STG}$	-55 to 150	$^\circ C$

Thermal Characteristics					
Parameter	Symbol	Typ	Max	Units	
Maximum Junction-to-Ambient <sup>A</sup>	$R_{\theta JA}$	28	40	$^\circ C/W$	
Maximum Junction-to-Ambient <sup>A</sup>					
Maximum Junction-to-Lead <sup>C</sup>	$R_{\theta JL}$	21	30	$^\circ C/W$	

**Electrical Characteristics (T<sub>J</sub>=25°C unless otherwise noted)**

Symbol	Parameter	Conditions	Min	Typ	Max	Units
<b>STATIC PARAMETERS</b>						
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	I <sub>D</sub> = 250μA, V <sub>GS</sub> =0V	30			V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 24V, V <sub>GS</sub> =0V			500	nA
I <sub>GSS</sub>	Gate-Body leakage current	V <sub>DS</sub> =0V, V <sub>GS</sub> =±12V			±100	nA
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> I <sub>D</sub> = 250μA	0.6	1.1	2.0	V
I <sub>D(ON)</sub>	On state drain current	V <sub>GS</sub> = 10V , V <sub>DS</sub> = 5V			45	A
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance	V <sub>GS</sub> = 10V, I <sub>D</sub> = 12A		8.3	10.5	mΩ
		V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 8A		9.7	12.0	mΩ
g <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = 15V, I <sub>D</sub> = 12A		9		S
V <sub>SD</sub>	Diode Forward Voltage	I <sub>S</sub> = 3A , V <sub>GS</sub> =0V		0.76	1.0	V
I <sub>S</sub>	Maximum Body-Diode Continuous Current				5	A

**DYNAMIC PARAMETERS**

C <sub>ISS</sub>	Input Capacitance	V <sub>GS</sub> =0V, V <sub>DS</sub> =25V, f=1MHz		3656		pF
C <sub>OSS</sub>	Output Capacitance			256		pF
C <sub>RSS</sub>	Reverse Transfer Capacitance			168		pF
R <sub>g</sub>	Gate resistance	V <sub>GS</sub> =0V, V <sub>DS</sub> =0V, f=1MHz			1.1	Ω

**SWITCHING PARAMETERS**

Q <sub>g</sub> (10V)	Total Gate Charge (10V)	V <sub>DD</sub> = 15V, V <sub>GEN</sub> = 4.5V, I <sub>D</sub> = 12A		30.5		nC
Q <sub>g</sub> (4.5V)	Total Gate Charge (4.5V)			23		nC
Q <sub>gs</sub>	Gate Source Charge			4.6		nC
Q <sub>gd</sub>	Gate Drain Charge			8.6		nC
t <sub>D(on)</sub>	Turn-On DelayTime	V <sub>DD</sub> = 15V, V <sub>GEN</sub> = 10V, R <sub>L</sub> = 1.1Ω R <sub>GEN</sub> =3Ω I <sub>D</sub> = 12A		5.5		ns
t <sub>r</sub>	Turn-On Rise Time			3.4		ns
t <sub>D(off)</sub>	Turn-Off DelayTime			49		ns
t <sub>f</sub>	Turn-Off Fall Time			5.9		ns
t <sub>rr</sub>	Body Diode Reverse Recovery Time	I <sub>F</sub> = 10A, di/dt=100A/μs		22		ns
Q <sub>rr</sub>	Body Diode Reverse Recovery Charge	I <sub>F</sub> = 10A, di/dt=100A/μs		12.5		nC

A: The value of R<sub>θJA</sub> is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with T<sub>A</sub>=25°C. The value in any given application depends on the user's specific board design. The current rating is based on the t<sub>s</sub> 10s thermal resistance rating.

B: Repetitive rating, pulse width limited by junction temperature.

C: The R<sub>θJA</sub> is the sum of the thermal impedance from junction to lead R<sub>θJL</sub> and lead to ambient.

D: The static characteristics in Figures 1 to 6,12,14 are obtained using 80μs pulses, duty cycle 0.5% max.

E: These tests are performed with the device mounted on 1 in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with T<sub>A</sub>=25°C. The SOA curve provides a single pulse rating.

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

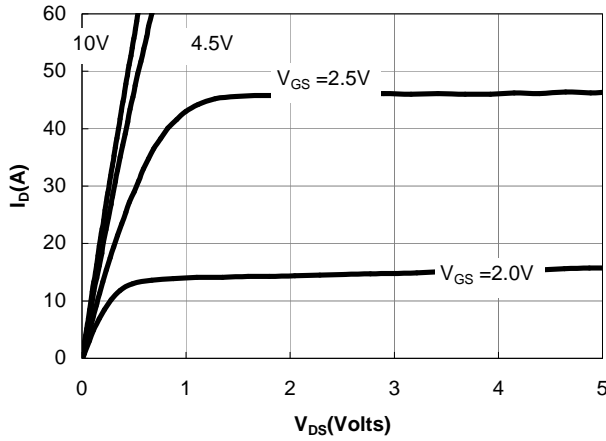


Figure 1: On-Regions Characteristics

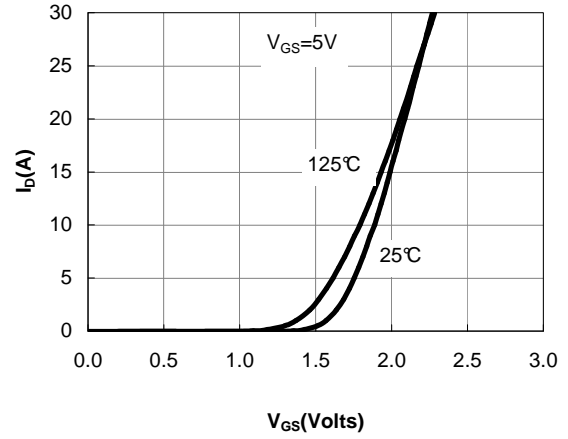


Figure 2: Transfer Characteristics

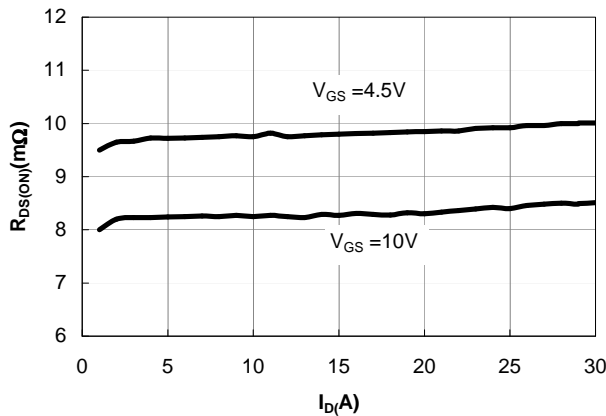


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

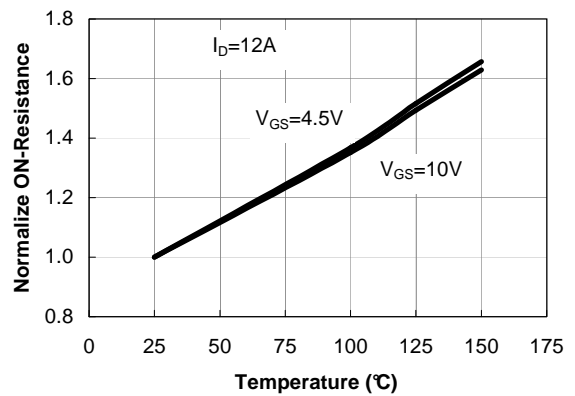


Figure 4: On-Resistance vs. Junction

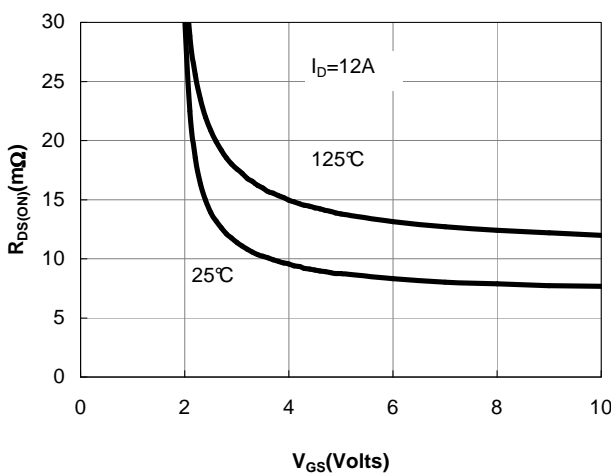


Figure 5: On-Resistance vs. Gate-Source Voltage

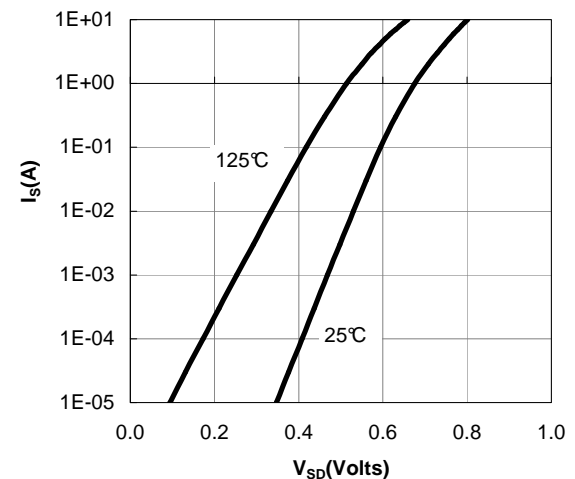


Figure 6: Body-Diode Characteristics

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

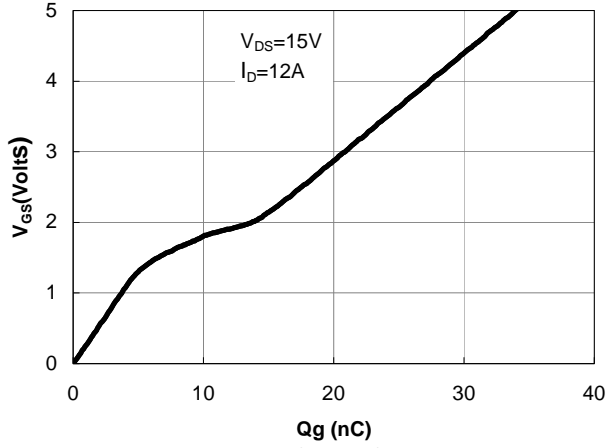


Figure 7: Gate-Charge Characteristics

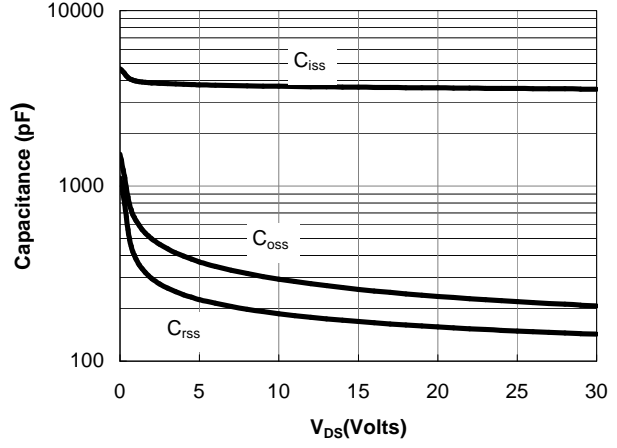


Figure 8: Capacitance Characteristics

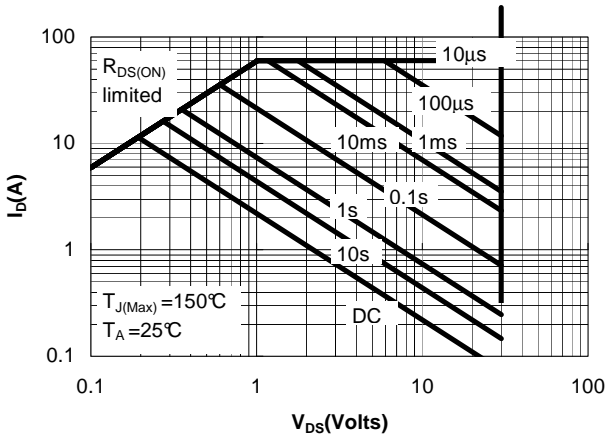


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

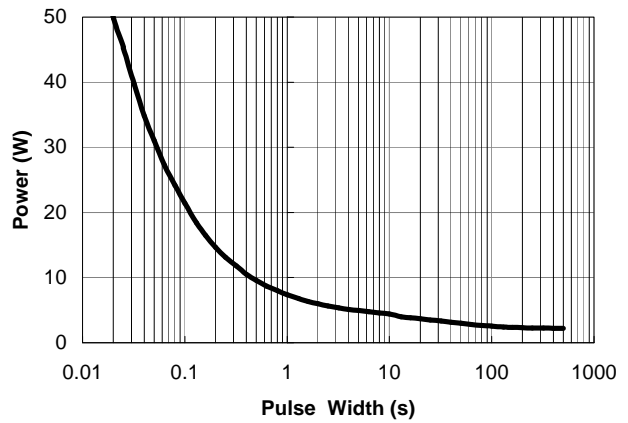


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

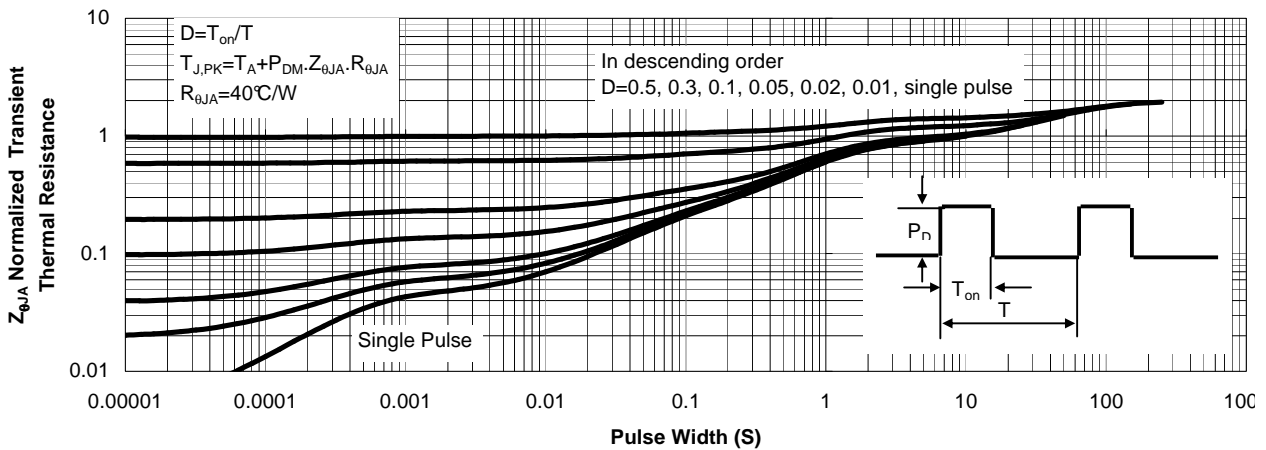
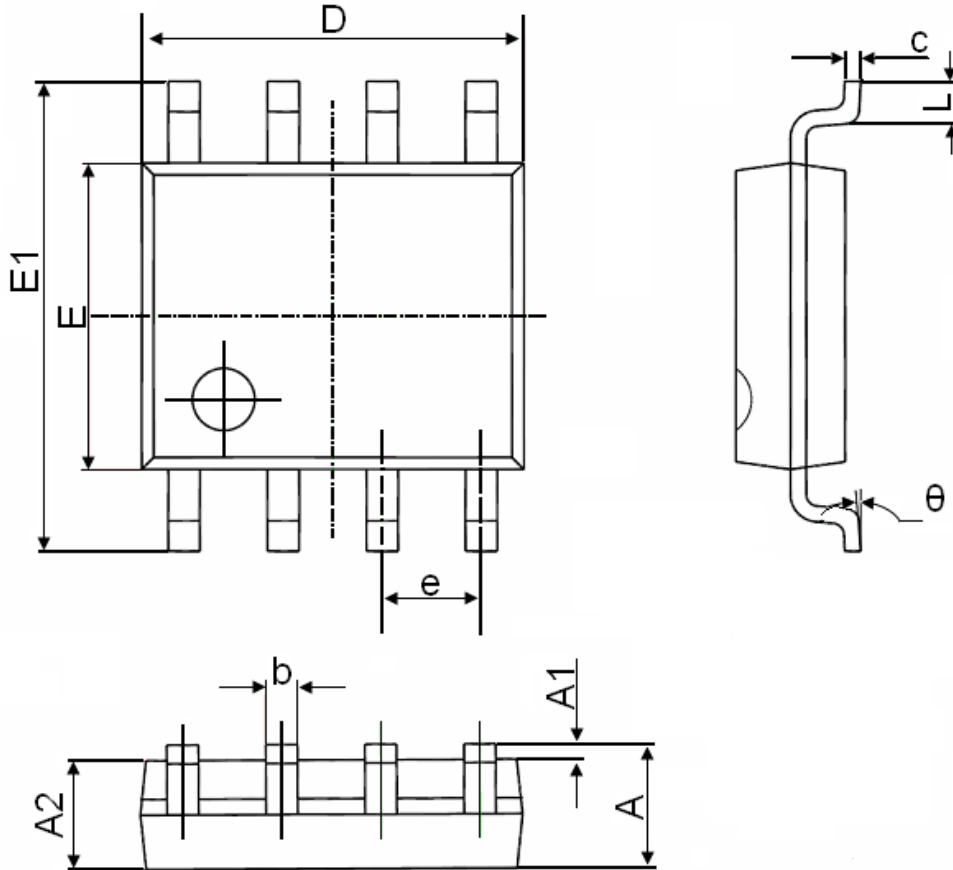


Figure 11: Normalized Maximum Transient Thermal Impedance

# SOP-8 Plastic-Encapsulate MOSFETS

4420

## SOP-8 Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.006	0.010
D	4.700	5.100	0.185	0.200
E	3.800	4.000	0.150	0.157
E1	5.800	6.200	0.228	0.244
e	1.270(BSC)		0.050(BSC)	
L	0.400	1.270	0.016	0.050
$\theta$	0°	8°	0°	8°

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[C3M0021120D](#)